

# Zichen Fan

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## EDUCATION

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- **University of Michigan** Ann Arbor, MI  
*PhD Candidate in ECE, Co-advisors: Prof. Dennis Sylvester and Prof. David Blaauw* Aug. 2019 – Nov. 2024 (exp.)
- **University of Michigan** Ann Arbor, MI  
*Master of Engineering in ECE, GPA: 4.0/4.0* Aug. 2019 – Apr. 2022
- **Tsinghua University** Beijing, China  
*Bachelor of EE, GPA: 3.7/4.0* Aug. 2015 – Jul. 2019
- **Duke University** Durham, NC  
*Summer Research Intern in ECE, Advisor: Prof. Yiran Chen* Jul. 2018 – Sept. 2018

## INDUSTRY

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- **Qualcomm** San Diego, CA  
*Machine Learning Engineering Intern, Qualcomm Research Center* May 2023 – Aug. 2023

## SELECTED PUBLICATION (GOOGLE SCHOLAR)

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- **Z. Fan**, et al. TaskFusion: An Efficient Transfer Learning Architecture with Dual Delta Sparsity for Multi-Task Natural Language Processing. *International Symposium on Computer Architecture (ISCA)*. 2023.
- S. Shoouri, M. Yang, **Z. Fan**, et al. Efficient Computation Sharing for Multi-Task Visual Scene Understanding. *International Conference on Computer Vision (ICCV)*. 2023
- P. Abillama, **Z. Fan**, et al. SONA: An Accelerator for Transform-Domain Neural Networks with Sparse Orthogonal Weights. *International Conference on Application-specific Systems, Architectures and Processors (ASAP)*. IEEE, 2023 (Best Paper)
- H. An, Y. Chen, **Z. Fan**, et al. A 8.09TOPS/W Neural Engine Leveraging Bit-Sparsified Sign-Magnitude Multiplications and Dual Adder Trees. *International Solid-State Circuits Conference (ISSCC)*. IEEE, 2023.
- **Z. Fan**, et al. Audio and Image Cross-Modal Intelligence via a 10TOPS/W 22nm SoC with Back-Propagation and Dynamic Power Gating. *IEEE Symposium on VLSI Circuits (VLSI-Symp)*. IEEE, 2022.
- Q. Zhang, H. An, **Z. Fan**, et al. A 22nm 3.5TOPS/W Flexible Micro-Robotic Vision SoC with 2MB eMRAM for Fully-on-Chip Intelligence. *IEEE Symposium on VLSI Circuits (VLSI-Symp)*. IEEE, 2022.
- **Z. Fan**, et al. ASP-SIFT: Using Analog Signal Processing Architecture to Accelerate Keypoint Detection of SIFT Algorithm. *IEEE Transactions on Very Large Scale Integration (T-VLSI) Systems*. 2019.
- **Z. Fan**, Z. Liu, et al. Design of Switched-Current Based Low-Power PIM Vision System for IoT Applications. *2019 IEEE Computer Society Annual Symposium on VLSI (ISVLSI)*. IEEE, 2019.
- **Z. Fan**, Z. Li, B. Li, et al. RED: A ReRAM-based Deconvolution Accelerator. *Design, Automation & Test in Europe Conference & Exhibition (DATE)*. IEEE, 2019.

## WORKING PAPER

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- **Z. Fan**, et al. AIMMI: Audio and Image Multi-Modal Intelligence via a 10TOPS/W 22nm Low Power SoC with 2MByte On-chip MRAM for IoT Devices. *Submitted to IEEE Journal of Solid-State Circuits (JSSC)*. IEEE, 2023.

## RESEARCH

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- **Multi-task Processing Transformer Accelerator** | Algorithm, Architecture University of Michigan  
*Co-advisors: Prof. Dennis Sylvester, Prof. David Blaauw and Prof. Hun-Seok Kim* Mar. 2022 - Present
  - Publications: ISCA 2023 (first author), ICCV 2023
  - Proposed an efficient Transformer inference algorithm by sharing both weight and activation from base task.
  - Proposed an efficient transfer learning algorithm for NLP and image/video applications

- Designed a heterogeneous architecture for accelerating Transformer-based multi-task scenario.
- Designed a task scheduling scheme to reduce off-chip memory access and increase computation utilization.
- Algorithm achieved averagely 73% number of FLOPs reduction with negligible accuracy loss.
- Architecture achieved  $1.48\times$ - $2.43\times$  speed-up and  $1.62\times$ - $3.77\times$  higher efficiency than SOTA Transformer accelerators
- **Multi-modal Signal Processing Accelerator** | Architecture, Circuit University of Michigan  
*Co-advisors: Prof. Dennis Sylvester, Prof. David Blaauw and Prof. Hun-Seok Kim* *Aug. 2019 - Feb. 2022*
  - Publications: VLSI-symp 2022 (first author), JSSC (first author), ISSCC 2023
  - Worked on the GAN-based audio compression algorithm, which achieved more than  $64\times$  compression rate for audio.
  - Worked on the audio-image/video cross modal verification algorithm.
  - Designed a  $12\text{mm}^2$  ultra-low-power multi-modal signal processor SoC in TSMC 22nm technology and taped out.
  - Designed an architecture that integrates a versatile neural engine with audio and image processing accelerators.
  - Proposed MRAM dynamic power gating technology and MRAM-weight cache architecture.
  - Demonstrated MRAM's advantages in IoT applications regarding power consumption and energy efficiency.
  - Proposed a dedicated system power domain design, used Cadence Innovus CPF Flow to handle power domains.
  - The  $0.25$ - $3.84$  mW SoC achieved 3-10 TOPS/W energy efficiency:  $1.4$  -  $4.5\times$  higher than SOTA DNN processors.
- **Millimeter-Scale Ultra-low-power Audio System** | Circuit, System University of Michigan  
*Co-advisors: Prof. Dennis Sylvester, Prof. David Blaauw and Prof. Hun-Seok Kim* *Mar. 2022 - Present*
  - Helped build the test environment for millimeter-scale ultra-low-power audio system.
  - Tested the voice activity detection behavior in audio system.
  - Joint tested the audio system with aforementioned multi-modal signal processing SoC.
- **Transform Domain Neural Network Accelerator** | Architecture, Circuit University of Michigan  
*Co-advisors: Prof. Dennis Sylvester, Prof. David Blaauw and Prof. Hun-Seok Kim* *Aug. 2021 - Mar. 2022*
  - Publications: ASAP 2023 (Best Paper Award)
  - Collaboratively designed a novel transform-domain neural network accelerator in which convolution operations are replaced by element-wise multiplications with sparse-orthogonal weights.
  - Architecture simulation showed up to  $5.2\times$  performance gain from traditional convolution accelerators.
  - Helped design a MRAM-logic asynchronous interface. Helped design a MRAM-based data pre-loading scheme.
- **Sign-Magnitude Neural Network Accelerator** | Architecture, Circuit University of Michigan  
*Co-advisors: Prof. Dennis Sylvester, Prof. David Blaauw and Prof. Hun-Seok Kim* *Oct. 2021 - Mar. 2022*
  - Publications: ISSCC 2023
  - Collaboratively designed a NN accelerator using bit-sparsified sign-magnitude multiplications and dual adder trees.
  - Helped tape out a 28nm test chip with both 2's complement NN accelerator and sign-magnitude NN accelerator.
  - System achieved 50% energy efficiency gain comparing to traditional 2's complement NN accelerator.
- **GNN-based Cost Prediction on Compiled Graph** | Algorithm, Compiler Qualcomm Research Center  
*Mentors: Mahesh Balasubramanian and Apoorva Gokhale Manager: Rishi Chaturvedi* *May 2023 - Present*
  - Used DNN compiler for compiling different DNN models and analyzed both high-level IR and low-level IR.
  - Ran compiled graphs and extracted instruction features and node-level cost as custom dataset.
  - Proposed a GNN-based cost prediction algorithm that used GNN pre-trained model and finetuning scheme.
  - Tested node attribute masking as pre-trained task and cost prediction as downstream task.
  - Proposed algorithm achieved  $> 95\%$  cost prediction accuracy and more than  $3\times$  speed-up than previous modeling.
- **Analog Signal Processing SIFT Accelerator** | Circuit Tsinghua University  
*Advisor: Prof. Fei Qiao* *Jul. 2017 - Jul. 2018*
  - Publications: T-VLSI 2019 (first author)
  - Worked on the SIFT acceleration system using analog signal processing architecture.
  - Proposed an analog circuit network that realized the keypoint detection part of SIFT.
  - System simulation achieved  $2.3\text{k}$  VGA frames/s, which is  $3.26\times$  faster than SOTA digital accelerators.
- **Near-sensor Current-based CIM Accelerator** | Circuit Tsinghua University  
*Advisor: Prof. Fei Qiao* *Oct. 2018 - Jun. 2019*
  - Publications: ISVLSI 2019 (first author)

- Proposed a switched-current based low-power computer-in-memory vision system.
- Designed current mode active pixel sensor and current mode compute-in-memory architecture.
- System simulation showed 1.45mW power consumption and up to 28.25TOPS/W energy efficiency.

- **RRAM-based CIM Deconvolution Accelerator** | Architecture

Duke University

*Co-advisors: Prof. Yiran Chen and Prof. Hai Li*

*Jul. 2018 - Sept. 2018*

- Publications: DATE 2019 (first author), T-CAD 2020
- Proposed an architecture for accelerating deconvolution using ReRAM-based compute-in-memory.
- Proposed the RRAM pixel-wise mapping scheme and deconvolution zero-skipping data flow.
- The proposed architecture achieved  $3.69\times \sim 31.15\times$  speed-up and up to 88.36% energy reduction on deconvolution.

## COURSE PROJECTS

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- EECS 427 (VLSI Design I [A+]): A 16bit RISC Processor with a 4-bit Time-Domain Mixed-Signal MAC Processor
- EECS 627 (VLSI Design II [A+]): A 130nm Configurable Neural Engine Design for Deep Learning Applications
- EECS 470 (Computer Architecture [A]): A P6-style 2-way Superscalar Out-of-Order Processor
- EECS 413 (Monolithic Amplifier Circuits [A+]): A 5Gbps Wide-bandwidth Transimpedance Amplifier
- EECS 545 (Machine Learning [A]): Music Style Transfer based on Autoencoder
- EECS 504 (Foundations of Computer Vision [A]): Segmentation Guidance for 3D Object Detection

## ACADEMIC SERVICE

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- **Reviewer:** JSSC, TCAS-I, TCAS-II

## SKILLS

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- **Languages:** C, C++, Python, MATLAB, Verilog, System Verilog
- **Tools:** Synopsys & Cadence Design Tools, Pytorch, Vivado, Spice

## AWARDS

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- ASAP 2023 Best Paper Award 2023
- Qualcomm Innovation Fellowship (QIF) Finalist 2023
- International Symposium on Computer Architecture (ISCA) Student Travel Grant 2023
- Rackham Conference Travel Grant 2022, 2023
- 3<sup>rd</sup> Place in Low-Power Image Recognition Challenge (LPIRC 2018), Track2 2018
- 2<sup>nd</sup> Prize in Tsinghua Excellent Student Research Training (SRT) Project 2018
- 3<sup>rd</sup> Prize in 35<sup>th</sup> Challenge cup of Tsinghua University 2017
- Meritorious Winner in Mathematical Contest in Modeling, COMAP 2017
- 1<sup>st</sup> Prize for the 32rd National Undergraduate Physics Olympic 2016
- Scholarship for Scientific and Technological Innovation 2016-18
- Scholarship for Academic Excellence 2015-16